High yield growth and doping of black phosphorus with tunable electronic properties

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Black phosphorus (BP) has recently attracted significant interest due to its unique electronic and optical properties. Doping is an effective strategy to tune a material’s electronic properties, however, the direct and controllable growth of BP with a high yield and its doping remain a great challenge. Here we report an efficient short-distance transport (SDT) growth approach and achieve the controlled growth of high quality BP with the highest yield so far, where 98% of the red phosphorus is converted to BP. The doping of BP by As, Sb, Bi, Se and Te are also achieved by this SDT growth approach. Spectroscopic results show that doping systematically changes BP’s electronic structures including band gap, work function, and energy band position. As a result, we have found that the air-stability of doped BP samples (Sb and Te-doped BP) improves compared with pristine BP, due to the downshift of the conduction band minimum with doping. This work reports a new method to grow BP and doped BP with tunable electronic structures and improved stability, and should extend the uses of these class of materials in various areas.

Introduction
Doping can significantly change the electronic, optical, magnetic, and chemical properties of materials, and has been widely used in semiconducting electronic and optoelectronic devices. The silicon semiconductor industry uses doping to change the transport characteristics of silicon-based electronic devices. In recent years, two-dimensional (2D) layer materials, such as graphene and transition metal dichalcogenides (TMDCs) have attracted much attention due to their unique properties and potential use in next-generation electronics, optoelectronics [1,2]. In the context of 2D materials, doping is also useful for changing their properties, such as to produce p- or n-type transport behavior, and changing Fermi levels, and bandgaps. Theoretical and experimental studies show that substitutional doping could change the band structure and open a bandgap in graphene [3,4], which significantly expands the applications of graphene. For instance, Wei et al. have grown N-doped graphene by a chemical vapor deposition (CVD) method and demonstrated that N atoms were substitutionally doped in the graphene lattice to produce n-type behavior, indicating that substitutional doping has changed the electronic properties of graphene [4]. Dai et al. reported the N-doping of graphene through the electrothermal reaction of graphene with ammonia, suggesting that edge doping was a new approach to dope graphene ribbons and could affect its properties [5]. In addition, Lv et al. have achieved substitutional doping of graphene with different atoms (B, N, or Si), and shown the use of doped graphene for molecule and gas sensing [6–8]. Besides graphene, Gong et al. have achieved substitutional doping of molybdenum disulfide (MoS2) by selenium with a broad range of selenium concentrations, resulting in changes in the optical bandgaps [9]. It is
therefore clear that doping is an effective strategy to change the properties of 2D materials.

Black phosphorus (BP) is a newly emerging 2D material which has high charge carrier mobility, a tunable band gap from visible to the mid-infrared region, and anisotropic electronic and optical properties, making it promising in high performance electronics and optoelectronics especially in the infrared range [10–13]. To realize BP-based electronics and optoelectronics, capability of tuning its electronic properties is of great importance and doping could be an effective strategy to achieve this. For instance, Kim et al. reported being able to change the bandgap of few-layer BP over a wide range by doping with potassium using an in situ surface doping technique [14]. However, compared to graphene and TMDCs, the direct growth and controlled doping of BP is still a challenge and less developed. Currently, BP is mostly grown by four methods: high temperature high pressure (HTHP) conversion of white phosphorus (WP) or red phosphorus (RP) [15–17], bismuth flux [18–20], mercury flux [21], and chemical vapor transport (CVT) growth [22–24]. Among these methods, HTHP needs a very high pressure, up to a few GPa, which is not feasible to generate economically. The bismuth and mercury flux methods are usually time consuming and use toxic chemicals, and have the shortcomings of a low conversion percentage of BP and small crystal sizes. Compared with other methods, CVT can grow BP at moderate temperature and pressure, and has recently been widely used to grow BP and doped BP [14,25–29]. For example, Wang’s group has developed a new method and achieved a BP conversion ratio (e.g., percentage conversion from RP or WP to BP) as high as 97% [30,32]. Further experimental results propose that through this method, BP was grown through a SnI2 mineralization and Sn24P19.3I8 compound served as an active site for BP growth [33]. Although lots of progress have been achieved in BP synthesis, it is still challenging to grow doped BP crystals with high doping concentration and high yield. Currently synthesis of doped BP crystals have been reported by few pioneering studies, where their doping concentrations are usually low, e.g., 0.1 at% in Te-doped BP [29], and 0.37 at% in Se-doped BP [27]. In addition, it is not clear how such doping affects the electronic structure and properties. Therefore, it is critical to develop a new approach to achieve a high yield growth and a high doping concentration to systematically tune its properties, which is an important prerequisite for its use.

Here, we report an efficient short-distance transport (SDT) growth approach and achieve a growth of 98% BP from RP, the highest value reported so far. This SDT approach can also directly grow BP doped with various elements like As (black arsenic phosphorus (As-BP) or b-AsP1−x with x in the range of 0–0.72), Sb (Sb-BP), Bi (Bi-BP), Se (Se-BP), and Te (Te-BP). Note that elements such as Sb, Bi, Se, and Te that are normally difficult to incorporate into BP, have been doped by our SDT growth method with doping concentrations as high as 1.2, 0.36, 0.45 and 0.42 at%, respectively, and these are among the highest doping concentrations reported so far. Significantly, materials characterization shows that the doping of BP effectively changes its electronic structures including bandgap and work function, which leads to an enhanced air stability of doped BP flakes compared with pristine BP flakes. Atomic force microscopy (AFM) has been applied to analyze the topographic features of both pristine and Sb (or Te) doped BP flakes as a function of ambient exposure time and we observed that doped BP flakes show a much smaller surface roughness increase than pristine BP flakes. Our studies indicate that doping of a proper element is a promising route to suppress the ambient degradation of BP, and it will accelerate the implementation of BP in future applications.

**Results and discussion**

**Growth of BP by SDT method under uniform temperature and its growth mechanism**

BP is grown through a direct reaction of source materials followed by a transport agent-assisted SDT process in an evacuated quartz ampule at high temperatures (Fig. 1a). Different from the mineralizer-assisted CVT growth method developed by Nilges et al. where a temperature gradient is needed in a long-distance transport (LDT) growth fashion [22,23] (Fig. 1b), our SDT growth approach uses a uniform temperature. The experimental details of this method are described in the Experimental Section. Fig. 1c and d show photos of the ampoules after typical SDT and LDT growth, respectively. One can clearly see that a large quantity of BP is grown by the SDT process while only few BP crystals could be observed using the LDT process, clearly showing that SDT method produces a much higher BP yield than the LDT method. In order to understand the growth mechanism of BP in this SDT process, we have performed systematic experiments with different growth parameters, including the type of transport agent, the mass ratio of Sn/SnI4, and the growth temperature. In order to study whether Sn and SnI4 are necessary reactants during the growth of BP, we have used other iodides, such as Pbi2, BiI3, I2, NH4I, NaI and KI instead of SnI4 as the reaction precursors to try to grow BP in both the SDT and LDT methods (Fig. S1, Supporting Information). We found that Sn is indispensable for BP growth, and no BP will grow without the Sn catalyst, consistent with a previous report [30]. It should be noted that the growth yield of BP (conversion ratio of BP to BP, i.e., mBP/mBP) in the SDT method is always higher than in the LDT method (Fig. S4a, Supporting Information). Furthermore, we have used different Sn/SnI4 mass ratios (1:1, 1:2, 1:3, 1:4, 2:1, 2:3, 3:1 and 3:2), Fig. S2 (Supporting Information) shows photographs of BP grown under different conditions. Fig. S4b (Supporting Information) compares the BP growth yield using the two methods with different Sn/SnI4 mass ratios. Based on this series of experiments, we conclude that the highest BP growth yield is obtained when the Sn/SnI4 mass ratio is 2:1. The growth yield of BP at this condition is over 98%, which is the highest value reported so far with previously reported results in the range 50–90% [22–24,31–34]. In addition, to understand the effect of temperature on BP growth, we have carried out a series of experiments at different temperatures and the growth yield of BP is shown in Fig. S3 and Fig. S4c (Supporting Information). These results show that BP crystals are grown at temperatures ranging from 400 to 800 °C, while the growth yield of BP is a maximum when the temperature is between 600 °C and 750 °C. This result is understandable because a low temperature would decrease the growth rate of BP, while a high temperature would make its nucleation difficult [35]. After growth, the purity of the BP was characterized by energy dispersive X-ray spectroscopy (EDX) analysis (Fig. S6,
Supporting Information). Fig. 1e summarizes the growth yield of BP using the different methods reported in the literature (HTHP method [28,29,36], sonochemistry [37], flux method [19,38,39] and CVT method [22,23,31–34,40]). Overall, the results show that a high growth yield and high purity BP are obtained by the SDT method developed in this work using a uniform temperature.

With these control experiments, we conclude that a uniform temperature and short-distance transport are two critical factors in achieving a high BP growth yield. When the temperature of the quartz ampoule slowly increases, RP, Sn, and SnI4 reactants begin to sublimate and fill the ampoule. Phosphorus gas reacts with Sn and SnI4 gas to form P-Sn-I compounds, which condense along the bottom of the ampoule, serving as nucleation sites for subsequent BP growth. During the slow cooling, the crystallization and growth of BP is assisted by the transport agent until the phosphorus gas is completely converted into BP. This process and growth mechanism is shown in Fig. S5 (see details in the Supporting Information).

**Structural characterization of BP**

We have used a comprehensive suite of microscopy and spectroscopy techniques to characterize the as-grown BP. Fig. 2a shows a photograph of BP crystal laths, densely distributed in a quartz ampoule and naturally separated from any by-products after growth. Optical (OM) and scanning electron microscope (SEM) images clearly show that the BP flakes have a lath-like morphology (Fig. 2b and c). High resolution transmission electron microscopy (HRTEM) studies were performed after exfoliating the BP onto a TEM grid. In Fig. 2d and e, a representative HRTEM image and the corresponding selected-area electron diffraction (SAED) pattern provide evidence that the BP flakes have an orthorhombic crystal structure. Lattice fringes with a 0.32 nm separation correspond to the (100) plane of BP, which is in good agreement with a previous report [41]. EDX spectroscopy results show that our BP samples are of high purity (Fig. S6, Supporting Information). X-ray photoelectron spectroscopy (XPS, Fig. 2f) indicates that the P 2p1/2 and 2p3/2 core level peaks are located at 130.8 and 129.9 eV, respectively, in good agreement with previously reported results for BP [22–24,31–34]. The absence of peaks from the oxidation states of phosphorous (POx) at 135.0 eV suggests that the as-grown BP is not oxidized.

The crystal structure of BP was also examined by X-ray diffraction (XRD, Fig. 2g). All the diffraction peaks can be indexed to BP crystals with a preferred orientation of (0 k 0). The most intense peak in the XRD pattern (Fig. 2h) is the (0 4 0) peak which has
a narrow full width at half maximum (FWHM) of 0.186°, indicating good crystallinity [38]. This was supported by Raman and photoluminescence (PL) spectroscopy results. The Raman spectrum (Fig. 2i) shows three distinct vibration modes at 360.9, 437.6 and 465.4 cm⁻¹, respectively corresponding to the $A_{1g}$, $B_{2g}$ and $A_{2g}$ phonon modes of BP. The PL spectrum (Fig. 2j) of monolayer BP, which was exfoliated from bulk BP and encapsulated by h-BN, shows a peak at 730.5 nm with a FWHM of 22.6 nm. This narrow FWHM correlates with the XRD results supports the high crystallinity of BP crystals [42]. In addition, we have studied the optical absorption of monolayer BP by reflectance measurements at 77 K using a microscopy set-up (Fig. S7d, Supporting Information). The result shows that monolayer BP has a bandgap of around 729 nm (1.70 eV, Fig. S7c, Supporting Information), consistent with a previous report [11]. All these results imply that we have obtained high quality BP by the SDT growth method with a uniform temperature.

**Doping of BP by various elements during SDT growth**

We have used the same SDT growth method with a uniform temperature to grow BP doped with various elements, including Te, Se, Bi, Sb, and As. Details of the growth conditions are provided in the Methods section. Figs. S8 and S9 (Supporting Information) shows photographs of the products (Te-BP, Se-BP, Sb-BP, Bi-BP and b-As$_x$P$_{1-x}$) after SDT growth. They show that doped BP samples have been grown and are densely distributed in the quartz ampoules, showing a similar morphology and layer structure to the BP (Fig. S10, Supporting Information). Fig. 3a are the XRD patterns of doped BP samples compared with pristine BP and show a downshift of diffraction angles for doped BP, indicating that the crystal lattice expands after doping (Fig. 3b). This result indicates an expansion of the BP crystal lattice as a result of doping and is attributed to the larger radius than P of the doping elements. We have also observed that with increasing atomic number of the doping elements (comparing Se with Te and Sb
with Bi), the growth yield of the doped BP decreases slightly. Similarly, when the doping concentration increases, for example when the As dopant concentration increases from 0% (pure BP) to 72.3%, the growth yield also decreases (Fig. S9, Supporting Information and Fig. 3c). It should be noted that it has always been a challenge to achieve high quality BP growth with a high yield, especially when doped with other elements, but here the growth yield was always above 90%, indicating the effectiveness of this method in growing BP and doped BP.

In order to study the structural change in the BP during doping, we have used several characterization methods to demonstrate the successful doping of elements such as Te, Se, Bi, Sb, and As. (a) XRD patterns of BP, Te-BP, Se-BP, Bi-BP, Sb-BP and b-As0.19P0.81. (b) Expanded patterns in (a) from 16.5° to 55° showing details of the (0 2 0), (0 4 0) and (0 6 0) peaks. (c) Growth yields of Te-BP, Se-BP, Sb-BP, Bi-BP, b-As0.19P0.81, b-A17s3BP, Te-BP and Bi-BP, showing the concentrations of each doping element. (d) Raman spectra of Sb-BP, Se-BP, Te-BP and Bi-BP. (e) P 2p and (f) Sb 3d XPS spectra of Sb-BP. (g) ICP-OES results of Sb-BP, Se-BP, Te-BP and Bi-BP, showing the concentrations of each doping element. (h) Raman spectra of BP, b-As0.19P0.81, b-A17s3BP and b-A17s4BP. The b-AsP Raman peaks gradually show up as As is doped into the BP lattice, while the BP Raman peaks fade away. (i) P 2p and (j) As 3d XPS spectra of b-A17s3BP. (k) EDX spectra of b-A17s3BP, b-A17s4BP and b-A17s5BP.

More interesting was the fact that two new peaks at 193.5 and 229.0 cm\(^{-1}\) appeared for all the doped BP samples (Fig. S11b, Supporting Information), which were not observed in BP. Previous theoretical studies suggested that these two peaks belong to the edge phonon vibrational modes of pristine BP [43,44], which are identified as \(~B_1\) and \(~B_3\) modes and are forbidden in pristine BP. Our results suggest that these two peaks may be activated by doping and could possibly provide a way to identify doped BP.

In order to study the structural change in the BP during doping, we have used several characterization methods to demonstrate the successful doping of elements such as Te, Se, Sb, and Bi- in BP, which are usually difficult to incorporate. Raman analysis show that the \(A_1^1\) (359.3 cm\(^{-1}\)), \(B_2^2\) (435.4 cm\(^{-1}\)), and \(A_2^2\) (463.3 cm\(^{-1}\)) peaks slightly red shifted (by 1.6 cm\(^{-1}\) for \(A_1^1\), 2.3 cm\(^{-1}\) for \(B_2^2\), and 2.1 cm\(^{-1}\) for \(A_2^2\)), when BP was doped with other elements (Fig. S11a, Supporting Information).
(Fig. S12, Supporting Information). The HRTEM images prove the good crystallinity of the doped BP samples and EDX mapping shows that Sb and Se dopants are uniformly distributed in the doped BP. Furthermore, we have performed inductively coupled plasma optical emission spectroscopy (ICP-OES) to quantitatively measure the dopant concentration and the results show that Sb-, Se-, Te- and Bi-doped BP contain dopant concentrations of 1.2, 0.45, 0.42 and 0.36 at %, respectively (Fig. 3g). We found that it becomes more difficult to dope elements into BP as their atomic radius increases. It should be noted that the dopant concentrations for the different elements are among the highest ever obtained [27,29], confirming the effectiveness of this SDT method to incorporate different elements into the BP lattice.

More interestingly, we have observed that arsenic (As), which is from the same chemical group as phosphorus, can be doped into BP crystals with high and defined concentrations in the uniform temperature SDT process. Raman characterization indicates that the intensity of the BP peaks decreases while the intensity of the peaks from b-As increases with increasing As concentration (Fig. 3h). For the b-As0.19P0.81 sample, we have observed two strong peaks at 131.2 and 130.4 eV in XPS characterization (Fig. 3i), corresponding to the P 2P1/2 and P 2P3/2 peaks. In addition, two new peaks at 41.8 and 42.4 eV related to As 3d5/2 and 3d3/2 peaks (Fig. 3j), proving the existence of As in the sample. Various dopant concentrations from 0% (pure BP) to 72.3% (b-As0.72P0.28) are achieved by changing the ratios of the starting materials including BP and grey arsenic (Fig. 3k), which is consistent with a previous report using LDT process [26,45]. These results are consistent with previous results [26,45], confirming the successful doping of As into BP.

**Tunable the electronic properties of doped BP**

We now focus on how doping changes the electronic structures of BP. Absorption spectra of As-, Sb-, Se-, Te-, and Bi-doped BP powder (the mixture of 5 mg sample powder and 100 mg KBr were grinding in a glove box filled with Ar gas) were examined using diffuse reflectance infrared Fourier transform (DRIFIT) spectroscopy under ambient conditions (Fig. 4a). The results show that after doping with these different elements the absorption edge shifts to the long wavelength region. The band gaps (Eg) of different samples can be calculated using the Tauc plot method (see Supporting Information) [43]. The ordinate of the spectra was calculated according to the Kubelka-Munk (K-M) method (see Supporting Information). Following this procedure, Eg values of pristine BP, Se-BP, Sb-BP, Bi-BP, b-As0.19P0.81, b-As0.41P0.59, and b-As0.72P0.28 samples were obtained from the [(hν * FR(ν))2 vs. hν] plots (Fig. 4b), and calculated to be 0.284, 0.278, 0.283, 0.287, 0.274, 0.203, 0.187 and 0.168 eV, respectively (Table S1, Supporting Information). The bandgap of pristine bulk BP obtained here is in agreement with earlier measurements [11]. The results show that the bandgaps of BP are modulated by doping, resulting in an increase in Te doping while leading a decrease for As, Sb, Bi and Se doping. Interestingly, one can see from Table S1 (Supporting Information) that the band gap of b-As0.19P0.81 decreases sharply when the concentration of As increases from 0% (pure BP) to 19.3%, and then decrease less significantly when the concentration of As increases from 19.3% to 41.0% and further to 72.0%. The results suggest that the band gaps do not scale linearly with the concentration of arsenic or phosphorus. The band gap of b-AsxP1-x (x = 0.19, 0.41, and 0.72) obtained from infrared absorption measurements agrees with results from our previous work [26]. These results clearly show that the bandgap of BP is modulated by doping.

In addition to the bandgap, the band structure of BP is also tuned by doping. We have performed ultraviolet photoelectron spectroscopy (UPS, hv = 21.22 eV, Fig. 4c and d) measurements to study the band position of pristine BP and doped BP samples in high vacuum (ca. 10^-9 Torr) without exposure to air, and these show the secondary electron cut-off energy (Ecut-off, Fig. 4c) and the Fermi level and valence band maximum (E/VBM, Fig. 4d) position of the samples. UPS was used to determine the work function (WF = hν – (Ecut-off – EV(Au))), where Ecut-off – EV(Au) denotes the secondary electron edge, and the position of the valence band maximum (E/VBM) relative to the Fermi level (EFermi). We calculated the E/VBM = EFermi of the pristine BP, Se-BP, Sb-BP, Te-BP, Bi-BP, b-As0.19P0.81, b-As0.41P0.59, and b-As0.72P0.28 samples to be 0.19, 0.14, 0.24, 0.26, 0.20, 0.10, 0.08 and 0.07 eV, respectively (Table S1, Supporting Information). As doped BP is As-doped, the EFermi is expected to shift closer to the E/VBM as filled states are emptied by electron transfer to the dopants, and the negatively charged doping products on the surface is expected to increase the vacuum level (E/Vac), which can effects contributing to an increased work function (Table S1, Supporting Information). In particular, b-As0.72P0.28 shows a more remarkable upshift of the E/VBM due to the high doping concentration of As. The evolution of the UPS spectra in the low kinetic energy region indicates that the work function of BP is remarkably modulated by doping (Table S1, Supporting Information), from 4.11 eV in BP to 4.25 eV in Sb-doped BP, and from 4.11 eV in BP to 4.21 eV in Te-doped BP. These results suggest that by controlled doping, a desired work function could be obtained in BP, and this is important for the electrical contact engineering of BP electronics and optoelectronics. In addition, by combining the E/VBM with the bandgap, which can adjust the position of the conduction band minima (E/CBM) of the BP sample, and to improve air-stability of BP. These band alignment results (Fig. 4e) are a useful guide for building BP-based heterojunctions and devices, because precise control of the band structure and alignment could engineer the carrier transport efficiency of the system.

**Stability of Sb and Te-doped BP flakes**

It is well known that BP is not stable in ambient environment, which significantly hinders its applications. To study the effect of doping on the ambient degradation of BP, we carried out AFM analyses on topographic features of the pristine BP flake, as well as Sb and Te-doped BP flakes as a function of exposure time (in lab light illumination, the humidity ranging from 70% to 91%, and the temperature ranging from 298 K to 303 K, Fig. 5 and Fig. S13, Supporting Information). Similar to the reports by Wood et al. [46] and Yang et al. [29], hole-shape features are observed to appear on the surface of pristine BP flake, Sb-, Te- and As-doped BP flakes due to their reaction with adsorbed water and/or oxygen on the surface [47,48]. Fig. 5a shows a pristine BP flake of 25 nm in as-exfoliated form with ambient exposure up to 16 days. The “hole” evolves into larger sizes with different shapes, some larger than 1 μm (Fig. S15, Sup-
Severe corrosion of the pristine BP flake is clearly observable. In contrast, hole is uniformly distributed with much smaller sizes on a Sb-doped BP flake (28 nm thick in as-exfoliated flake) and Te-doped BP flake (31 nm thick in as-exfoliated flake), shown in Fig. 5b and c, with exposure up to 16 days. Surprisingly, with the further exposure to 16 days, the holes show little further change in size and shape. Even after 16 days of exposure, no severe corrosion is observable on the Sb and Te-doped BP flakes. Different from Sb and Te-doped BP flakes, the holes on the surface of b-As0.19P0.81 flakes grow much...
bigger and faster in size and diameter than pristine BP flakes (Fig. 5d). The growth of hole on the flakes implies increase in surface roughness (see the height profiles in Fig. S14, Supporting Information). With increased exposure time, roughness of the Sb- and Te-doped BP flakes show much smaller increase than that of the pristine BP flake while As-doped BP flakes show a much faster increase in surface roughness (Fig. 5e). Besides surface roughness, thickness reduction is another parameter to quantify the air-stability of BP flakes. It could be observed that both pristine BP flake, Sb (Te)-doped BP flakes and As-doped BP flakes show a monotonic decrease in thickness with increased exposure time (Fig. 5f). It should be noted that after exposure to ambient condition for 8 days, the exfoliated b-As_{0.19}P_{0.81} flakes almost disappeared, while pristine BP flake only experienced a thickness reduction by 24% (6.0 nm, from 25 to 19 nm) and Sb- and Te-doped BP flakes experience a 10% and 9% reduction respectively, as shown in Fig. 5f. With further exposure to ambient environment, the pristine BP flake experienced a thickness reduction by 32% (8.0 nm, from 25 to 17 nm) after an exposure of 16 days, while the Sb-doped and Te-doped BP flake experienced only 14.3% (4.0 nm, from 28 to 24 nm) and 9.7% (3.0 nm, from 31 to 28 nm) reduction in 16 days respectively, as shown in Fig. 5f.

As revealed in recent studies on the role of oxygen and water in ambient degradation of BP [29,46–48], the ambient degra-
tion of BP is initiated by contact with oxygen rather than water, which leads to the first formation of P2O5 on the surface. In the presence of water, however, the produced P2O5 can be removed from the surface owing to its reaction with moisture to form phosphoric acid [49], and the BP beneath is exposed again to oxygen for continuous oxidation. Therefore, prevention of the initial reaction of BP with oxygen becomes crucial to inhibit the ambient degradation of BP. The energy band alignment in Fig. 4e shows that, the VBM and CBM of pristine BP with respect to vacuum energy are −4.30 and −4.02 eV separately, which gives a band gap (Fig. 4b) of 0.284 eV. With this sized band gap, the pristine BP can produce excitons under ambient light. Furthermore, the redox potential of O2/O2− is just located in the band gap (Fig. 5g). Thus, the photo-generated electrons can transfer much easier from the conduction band of b-As0.19P0.81 to the O2 on the surface and generate O2. Under this circumstance, the photo-generated electrons can transfer much easier from the conduction band of BP to the O2 on the surface and generate O2, which would be apt to further react with the p-doped BP. Sb and Te doping will downshift the CBM of BP significantly, making it closer or even below the redox potential of O2/O2−, and generate O2.

Conclusions
We have developed a powerful SDT method using a uniform temperature to grow high-quality BP and doped BP with the highest growth yield up to 98%. In addition, uniform and controllable doping of various elements into BP was achieved with the same method, with the highest dopant concentrations reported so far. Structural and optical characterizations show that the as-grown pristine and doped BP have high crystallinity. In addition, we have performed systematic studies and reported for the first time that doping can effectively modulate the electronic structures of BP based materials, including their VBM, CBMs and work functions. More importantly, we have revealed experimentally and theoretically that doping with suitable elements (e.g., Sb, Te) could be an effective strategy to improve the chemical stability of BP, which would benefit its fundamental research and applications. We envision that the doping of BP with tunable properties will significantly expand the uses of these materials in various applications.

Materials and methods

Growth of BP by the SDT method at a uniform temperature
Bulk BP crystals were grown by the SDT method using a uniform temperature. In a typical experiment, a mixture of RP (500 mg, lump, 1–5 mm, 99.999% metals basis, Alfa Aesar), Sn (20 mg, powder, 100 mesh, 99.999%, Alfa Aesar), and SnI4 (10 mg, granule, 99.999%, Alfa Aesar) were enclosed in an evacuated quartz ampoule (length: 100 mm; inner diameter: 11 mm; wall thickness: 2 mm), pumped down to 0.1 mbar using a turbo pump, and sealed under a H2 flame. Later, the ampoules were placed horizontally in a muffle furnace with a uniform heating zone. The furnace was heated to 600 °C at a heating rate of 1 °C min−1. After holding at 600 °C for 2–8 h, the furnace was cooled to 500 °C in 8–15 h, where it was held for another 1–4 h. Cooling from 500 °C to 250 °C in 4–20 h was then carried out, followed by a final cool to room temperature. After growth, the BP crystals were found inside the ampoule. In order to study the growth mechanism of BP, control experiments were carried out using different transport agents including BiI3 (10–20 mg, granular, 99.99% metals basis, Alfa Aesar), PbI2 (10–15 mg, granular, 99.99% metals basis, Alfa Aesar), I2 (10–20 mg, granular, 99.99% metals basis, Alfa Aesar), NH4I (5–12 mg, granular, 99.999% metals basis, Macklin company), NaI (15–20 mg, granular, 99.99% metals basis, Alfa Aesar), and KI (15 mg, granular, ≥99.0%, Alfa Aesar). These transport agents were used to replace SnI4 while maintaining the other growth conditions. In addition, we also studied the effect of Sn/SnI4 mass ratio (1:1, 1:2, 1:3, 1:4, 2:1, 2:3, 3:1 and 3:2) and growth temperature (ranging from 400 to 800 °C) on the growth of BP (Fig. S1–3 in Uniform Temperature images). The as-synthesized BP crystals were kept in a glove box filled with Ar gas.

Growth of BP by the LDT method under a temperature gradient
As a comparison, BP growth experiments by a LDT method with a temperature gradient were also performed, following previous studies [22,23]. The starting materials (RP, Sn, and SnI4) were sealed in a quartz ampoule and placed in a horizontal quartz tube furnace, whose hot zone was heated from room temperature to 650 °C in 7 h and kept at this temperature for 2–8 h. The empty side of the quartz ampoule was located in the low temperature zone (T = 550 °C) and remained at this temperature throughout the growth. The ampoule was then cooled to room temperature at a slow cooling rate of 50 °C per hour. After growth, BP crystals were found only in the low temperature zone of the ampoule (Figs. S1–3 in Temperature gradient images). The as-synthesized BP crystals were kept in a glove box filled with Ar gas.

Growth of doped BP by the SDT method with a uniform temperature
Doped BP crystals were synthesized by two different processes. In the first process, we used RP (500 mg), Sn (20 mg), SnI4 (10 mg), and metals like Sb (20 mg, powder, 100 mesh, low oxide, 99.999% trace metal basis, Sigma-Aldrich), Bi (10 mg, powder, 100 mesh, ≥99.99% trace metal basis, Sigma-Aldrich), Se (10 mg, powder, 100 mesh, 99.99% trace metal basis, Sigma-Aldrich), or Te (10 mg, pieces, 99.999% trace metal basis, Sigma-Aldrich) as reactants. In the second process, we used RP (500 mg), Sn (20 mg), TeI4 (40 mg, granular, 99.99% metal basis, Alfa Aesar), SbI3 (40 mg, granular, 99.99% metal basis, Alfa Aesar), or BiI3 (40 mg, granular, 99.99% metal basis, Alfa Aesar) as reactants. The mixture was placed in quartz ampoules which were pumped down to 0.1 mbar, and sealed under a H2 flame. The ampoules were placed horizontally in the heating zone of
a muffle furnace. After inserting the ampoules, the muffle furnace was heated to 650–800 °C at a heating rate of 1 °C min⁻¹. After holding there for 4–10 h, the furnace was cooled to 500 °C in 8–20 h, and held at this temperature for another 2–8 h. It was then cooled to 250 °C in 6–15 h, followed by a final cooling to room temperature. After growth, the doped BP crystals were found throughout the quartz ampoule (Fig. S8). The as-synthesized doped BP crystals were kept in a glove box filled with Ar gas.

**Growth of composition-tunable b-AsₓP₁₋ₓ by the SDT method at a uniform temperature**

The b-As₀.₁₉P₀.₈₁ and b-As₀.₄₁P₀.₅₉ samples were prepared from a mixture of gray arsenic (111.6 mg and 154.3 mg, lump, purity ≥99.995%, American Xtal Technology Inc.) and RP (138.4 mg and 95.7 mg) with molar ratios of 1:3 and 2:3, respectively. Sn/SnI₄ (10 mg/5 mg per 250 mg batch) were added to the starting materials and acted as transport agents to promote the phase transition and crystal growth. The b-As₀.₇₂P₀.₂₈ samples were prepared from a mixture of gray arsenic (576.2 mg) and RP (48.8 mg) with a molar ratio 83:17. The transport agent was lead(II) iodide (PbI₂, 12 mg per 625 mg batch). All chemicals were enclosed in a quartz ampoule, which was pumped down to 0.1 mbar using a turbo pump, and sealed under a H₂ atmosphere. A muffle furnace was used for the heating process. The b-As₀.₁₉P₀.₈₁ samples were grown using the following heating procedure. (i) Heat the starting materials to 650 °C in 8 h and hold for 5 h, (ii) cool to 550 °C in 7.5 h and hold for 6 h, (iii) further cool to 500 °C and hold for 8 h, and (iv) cool to room temperature within 20 h. The b-As₀.₄₁P₀.₅₉ samples were grown with the following heating program. (i) Heat to 550 °C in 8 h and hold for 6 h, (ii) cool to 500 °C in 2 h and hold for 8 h, and (iii) cool to room temperature in 20 h. For b-As₀.₇₂P₀.₂₈ samples, the following heating program was applied: (i) heat to 550 °C within 8 h and hold for 84 h at this temperature, and (ii) cool down to room temperature within 20 h. After growth, the b-AsₓP₁₋ₓ crystals were found throughout the quartz ampoule (Fig. S9). The as-synthesized b-AsP crystals were kept in a glove box filled with Ar gas.

**Materials characterization**

Optical images of the bulk BP crystals were taken using an optical microscope (Carl Zeiss AXIO Microscopy, USA). Raman measurements (Horiba LabRAM HR-Evolution, Horiba, Japan) were performed through a 100× objective lens with a laser excitation wavelength of 532 nm. To avoid laser-induced damage to the samples, all spectra were recorded with a laser power less than 22 μW. To analyze elemental composition of the samples, X-ray photoelectron spectroscopy (XPS, monochromatic Al Kα X-rays, Thermo Fisher ESCALAB 250XI, England), scanning electron microscopy (SEM, 15 kV, Hitachi SU8010, Japan) coupled with energy-dispersive X-ray spectroscopy (EDS) (HITACHI SU8010, Japan), and inductively coupled plasma optical emission spectroscopy (ICP-OES, Instrument, Arcos II MV, Germany) were used. High-resolution transmission electron microscopy (HRTEM) (FEI Tecnai G2 F30, 300 kV, USA) and powder X-ray diffraction (XRD, Cu Kα radiation, λ = 0.15418 nm, Bruker D8 Advance, Germany) were used to examine the purity and crystallinity of both the BP and doped BP. Fourier-transform infrared spectroscopy (FTIR, Thermo Scientific Nicolet iS 50, USA) was used to determine the bandgaps of the BP and doped BP, and ultraviolet photoelectron spectroscopy (UPS, PHI 5000 VersaProbe II, England) was used to determine the valence band edge and work function. Valence-Band Region of UPS spectra, measured under –10 V bias, the work function is calculated with equation WF = ħν – (E_{cut-off} – E_{F(Au)}), where the E_{F(Au)} is the Fermi level of reference Au under –10 eV bias. Atomic force microscope (AFM) measurements were performed by using normal tapping mode under ambient condition on a Veeco Dimension 3000. Shortly after exfoliation, AFM images were collected and thicknesses of doped BP flakes were determined from height profiling. AFM scanning was further performed on a few selected doped BP flakes after exposure at ambient condition for various lengths of time.

**Data availability**

The data that support the plots within this paper and other findings of this study are available from the corresponding author upon reasonable request.

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**Author contributions**

M. L., S. F., and B. L. conceived the idea. M. L. conducted most materials growth and characterization experiments. S. Z. performed PL and analysis under the supervision of F. W. Y. H. and L. T. performed some of the XRD, XPS, AFM, and TEM characterization and analysis. J. L. discussed the results and helped prepare the figures. B. L. supervised the project and directed the research. M. L., S. F., Y. H., and B. L. interpreted the results and wrote the manuscript with feedback from the other authors. M. L. and S. F. contributed equally.

**Appendix A. Supplementary data**

Supplementary data to this article can be found online at https://doi.org/10.1016/j.mattoday.2019.12.027.

**References**

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